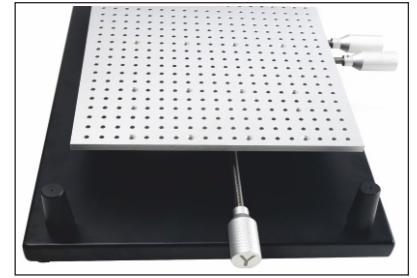


# HIGH PRECISION MANUAL SOLDER PASTE PRINTER

# FP-2636



## Features

The **FP2636** Manual Solder Printer for Framed Stencils is a simple way to apply solder to your PCBs every time. Proper solder application is frequently overlooked as a critical step in the SMD process. Without careful control of the placement and thickness of the solder paste, the results of reflow soldering can be amateur at best, to nonfunctional at worst. The operation of the printer is simple. First, clamp a framed stencil (available at very low cost from most PCB manufacturing houses) into the printer. Then, place the PCB on the included locator fixtures. Using the Vernier controls, move the PCB fixture until the solder pads perfectly align with the holes. Finally, move the solder over the stencil with the squeegee blade (included).

## Technical specifications

Max Frame Size	: 500 x 400 mm
Max PCB Size	: 260 x 360 mm
Screen Stencil Size	: 260 x 360 mm
PCB Thickness	: 0.5-10mm
Platform Height	: 190 mm
Repeatability	: $\pm 0.01$ mm
Max Rotation Angle	: $\pm 15^\circ$
Fine Adjustment Range	: Z-axis $\pm 15$ mm X-axis $\pm 15$ mm Y-axis $\pm 15$ mm
Positioning Pin Size	: 1mm, 1.5mm, 2.0mm, 2.5mm & 3mm
Overall Dimensions	: 660 x 470 x 245mm
Net Weight	: 11.55 Kg
Gross Weight	: 14.0 Kg

Sole Exclusive Distributor for Sales & Services of NeoDen Products in INDIA

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